

Vishay Siliconix

# P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
- 60	0.120 at V <sub>GS</sub> = - 10 V	- 4.7	8 nC		
	0.150 at V <sub>GS</sub> = - 4.5 V	- 4.2	OIIC		

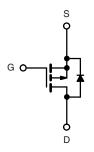
### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

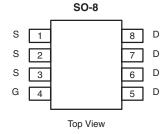


### **APPLICATIONS**

· Primary Side Switch



P-Channel MOSFET



Ordering Information: Si9407BDY-T1-E3 (Lead (Pb)-free)

Si9407BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 60	v		
Gate-Source Voltage		V <sub>GS</sub>			± 20
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$T_C = 25 ^{\circ}C$ $T_C = 70 ^{\circ}C$		- 4.7 - 3.8		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 3.2 <sup>b, c</sup>		
T <sub>A</sub> = 70 °C  Pulsed Drain Current (10 μs Width)		I <sub>DM</sub>	- 2.6 <sup>b, c</sup> - 20	Α	
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_{\Delta} = 25 ^{\circ}C$	I <sub>S</sub>	- 4.2 - 2 <sup>b, c</sup>		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 15		
Single-Pulse Avalanche Energy		E <sub>AS</sub>	11	mJ	
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	P <sub>D</sub>	5 3.2 2.4 <sup>b, c</sup> 1.5 <sup>b, c</sup>	w	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>		R <sub>thJA</sub>	42	53	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	19	25	J	

### Notes:

a. Based on T<sub>C</sub> = 25 °C.
b. Surface Mounted on 1" x 1" FR4 board.

d. Maximum under Steady State conditions is 85 °C/W.

# Si9407BDY

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 50		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1Β = - 250 μΑ		4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	1	V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 20			Α	
	В	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.2 A		0.100	0.120		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2.9 A		0.126	0.150	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 3.2 A		8.5		S	
Dynamic <sup>b</sup>	•			•	•	•	
Input Capacitance	C <sub>iss</sub>			600		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz		70			
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
Total Oats Observe		V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.2 A		14.5	22		
Total Gate Charge	I Gate Charge		8	12	1		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.9 \text{ A}$		2.2		nC	
Gate-Drain Charge	$Q_{gd}$			3.7			
Gate Resistance	$R_{g}$	f = 1 MHz		14		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			30	45		
Rise Time	t <sub>r</sub>	$V_{DD} = -30 \text{ V}, R_{L} = 11.5 \Omega$		70	105	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.6 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		40	60	ns -	
Fall Time	t <sub>f</sub>			30	45		
Turn-On Delay Time	t <sub>d(on)</sub>			10	15		
Rise Time	t <sub>r</sub>	$V_{DD} = -30 \text{ V}, R_{L} = 11.5 \Omega$		13	20	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.6 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		35	55		
Fall Time	t <sub>f</sub>			30	45		
<b>Drain-Source Body Diode Characteris</b>	tics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.2	Α	
Pulse Diode Forward Current	I <sub>SM</sub>				- 20		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = -2 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	50	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 2 A, dl/dt = - 100 A/μs, T <sub>J</sub> = 25 °C		35	60	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$\frac{1}{1}$ $\frac{1}$		16			
Reverse Recovery Rise Time	t <sub>b</sub>	]		14		ns	

### Notes:

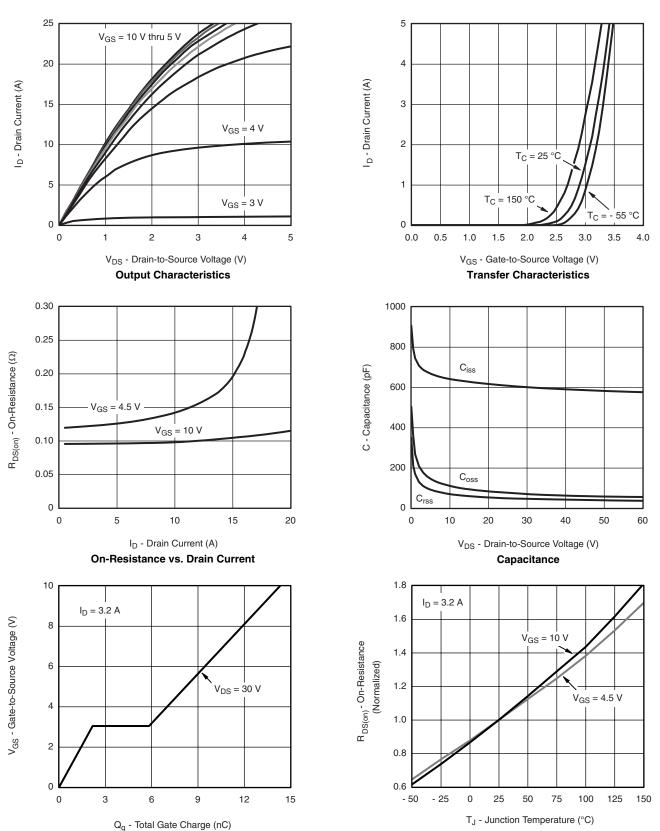
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



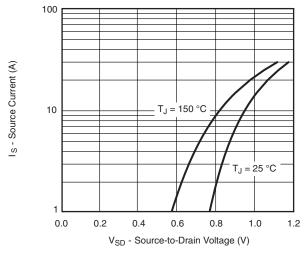
**Gate Charge** 

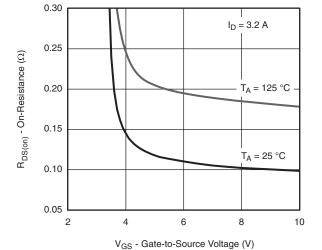
On-Resistance vs. Junction Temperature

# Si9407BDY

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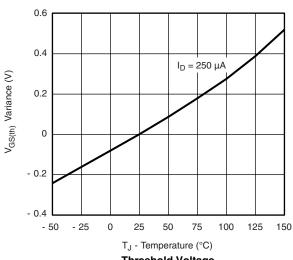
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

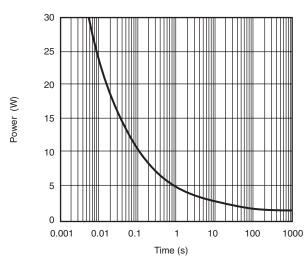




Source-Drain Diode Forward Voltage

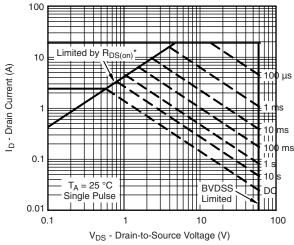






**Threshold Voltage** 

Single Pulse Power, Junction-to-Ambient



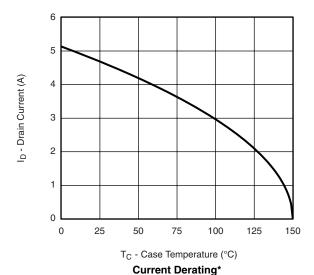
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

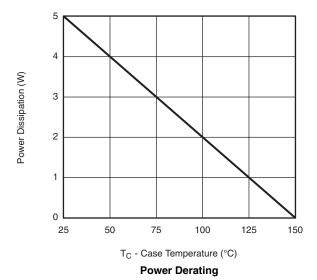
Safe Operating Area



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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





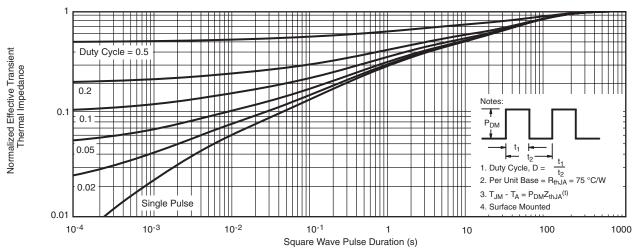
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

# Si9407BDY

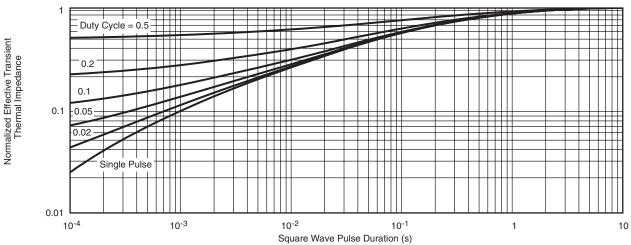
# Vishay Siliconix



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?69902">www.vishay.com/ppg?69902</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

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### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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